

[54] SLIP-ON HEAT SINK FOR LONG INTEGRATED-CIRCUIT MODULES

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[**] Term: 14 Years

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[52] U.S. Cl. D13/23

[58] Field of Search D13/23; 174/16 HS; 357/81; 165/80, 80 A, 80 B

[56] References Cited

U.S. PATENT DOCUMENTS

- 3,548,927 12/1970 Spurling 174/16 HS X
- 4,054,901 10/1977 Edwards et al. 174/16 HS X

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[57] CLAIM

The ornamental design for a slip-on heat sink for long integrated-circuit modules, substantially as shown and described.

DESCRIPTION

FIG. 1 is an enlarged perspective view of a slip-on heat sink for long integrated circuit module showing my new design, the module being shown in broken lines for illustrative purposes only;

FIG. 2 is a front elevational view thereof;

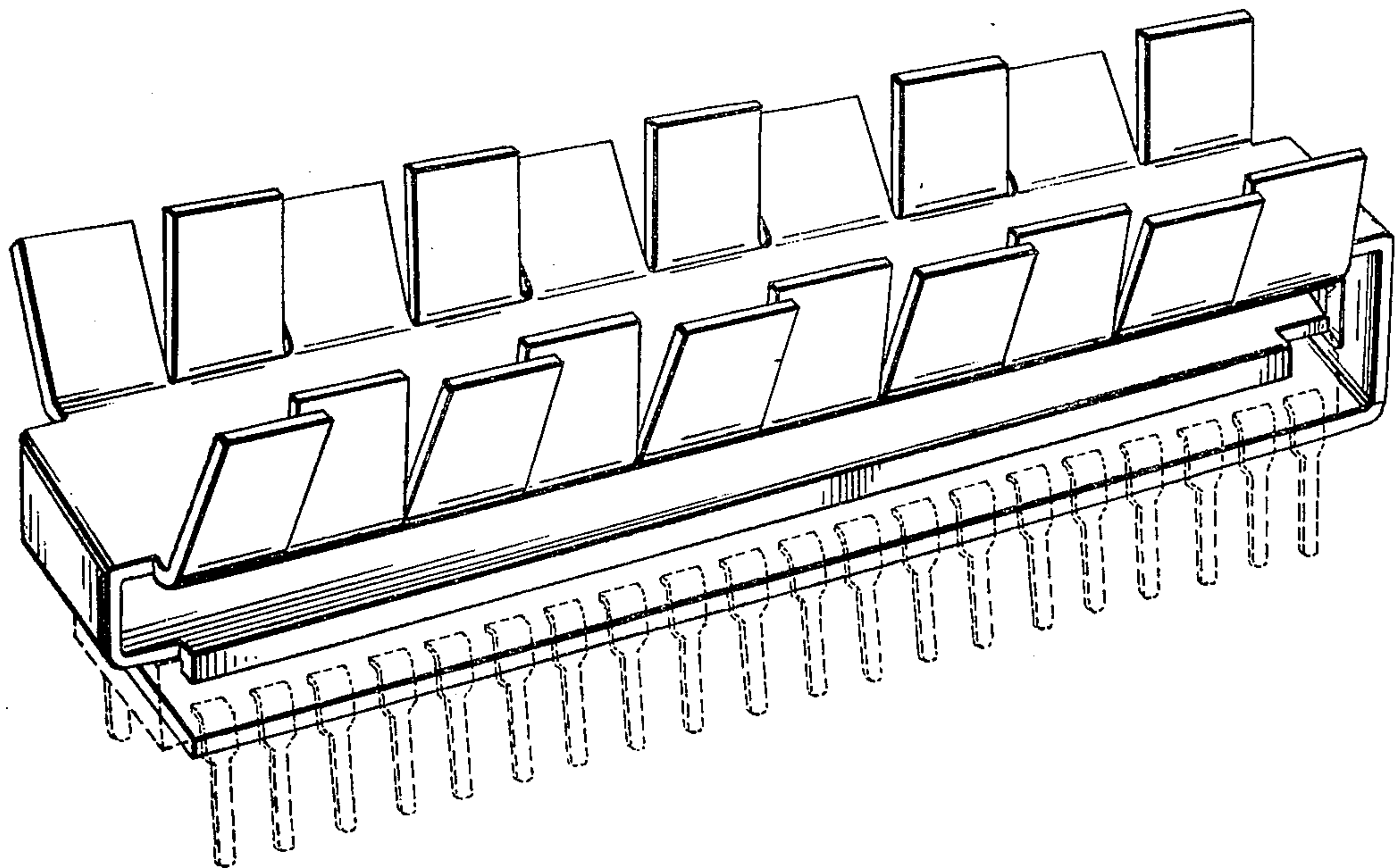
FIG. 3 is a top plan view thereof;

FIG. 4 is a bottom plan view thereof;

FIG. 5 is a rear elevational view thereof;

FIG. 6 is a right side elevational view thereof;

FIG. 7 is a left side elevational view thereof.



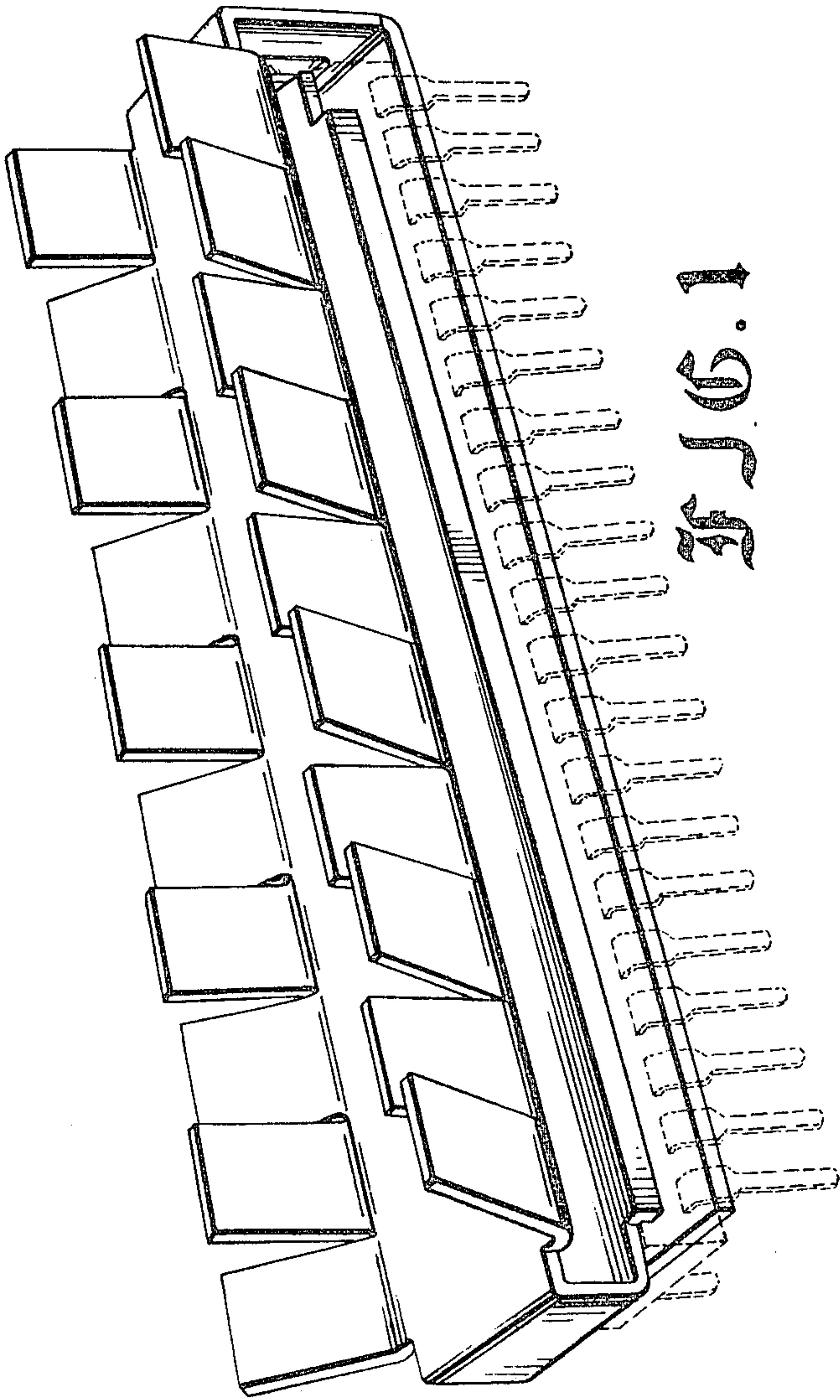


FIG. 1

FIG. 3

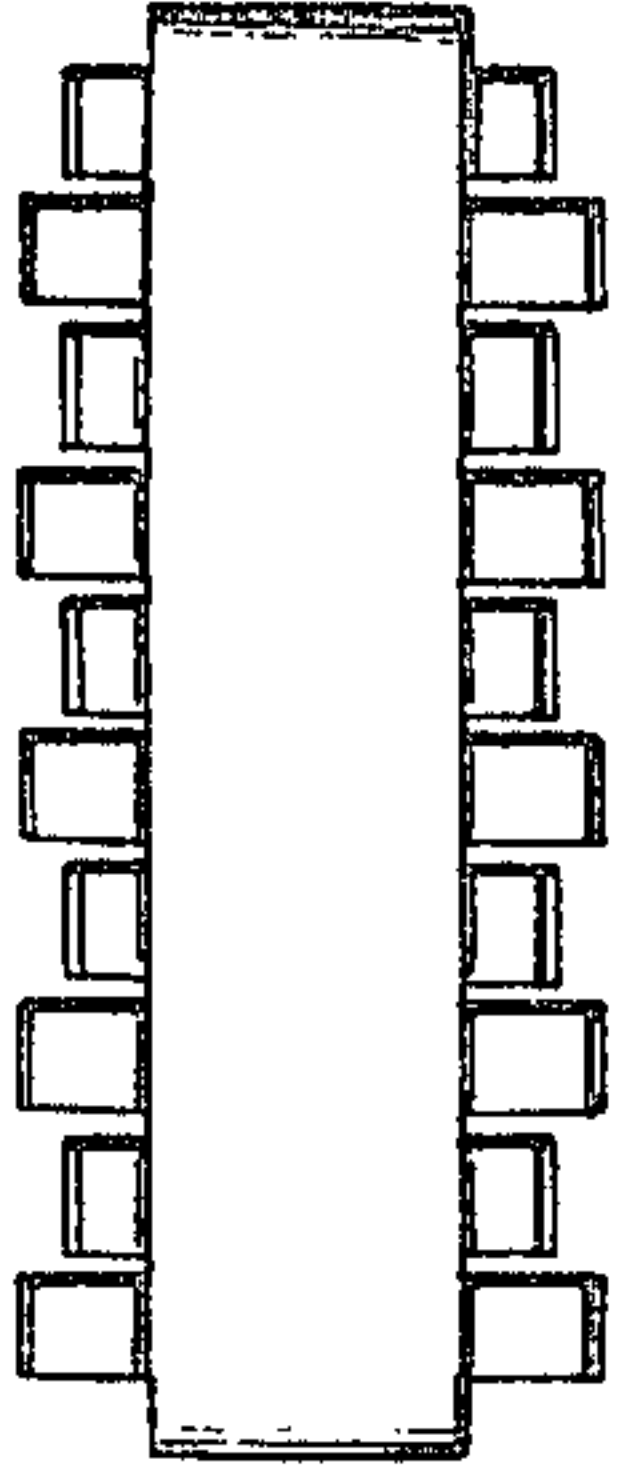


FIG. 4

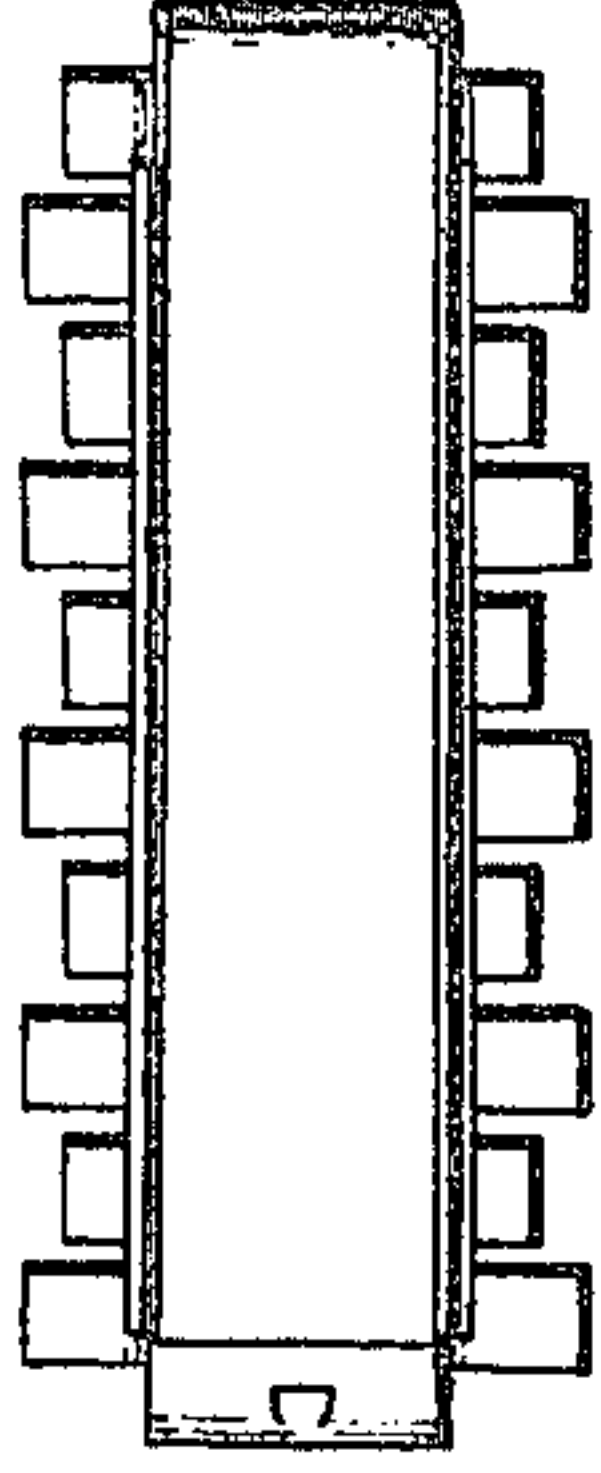


FIG. 6

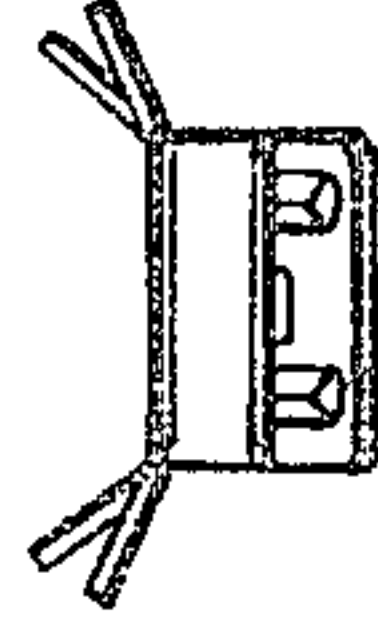
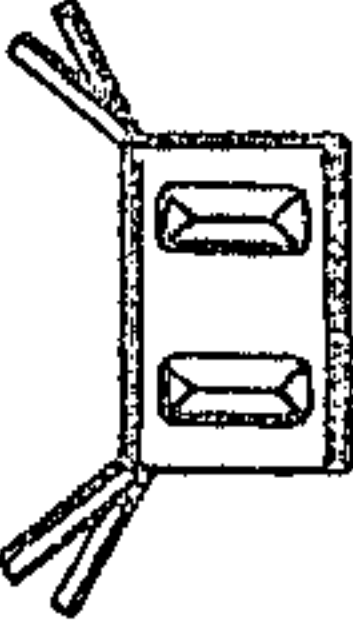


FIG. 7

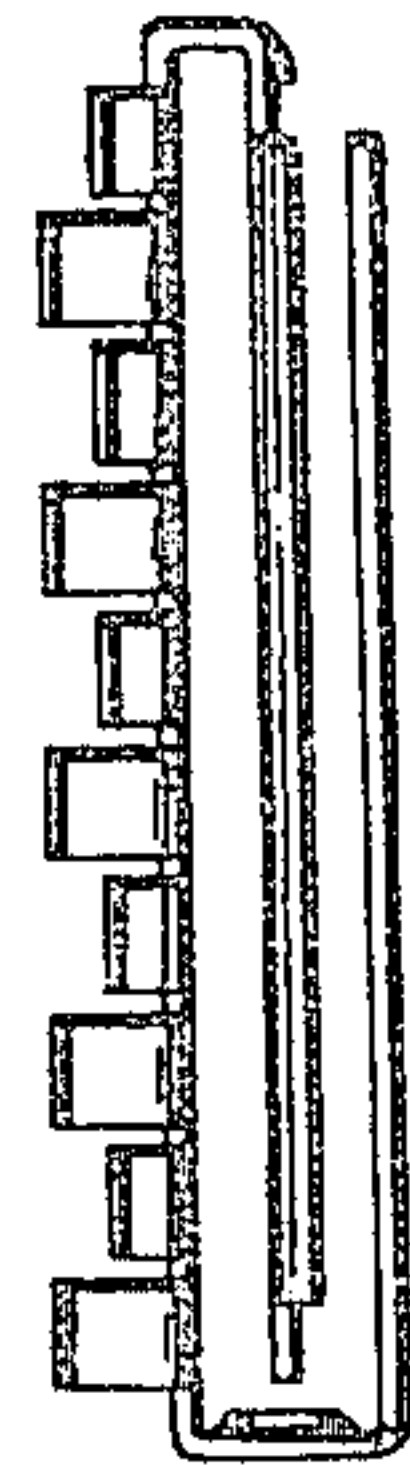


FIG. 5

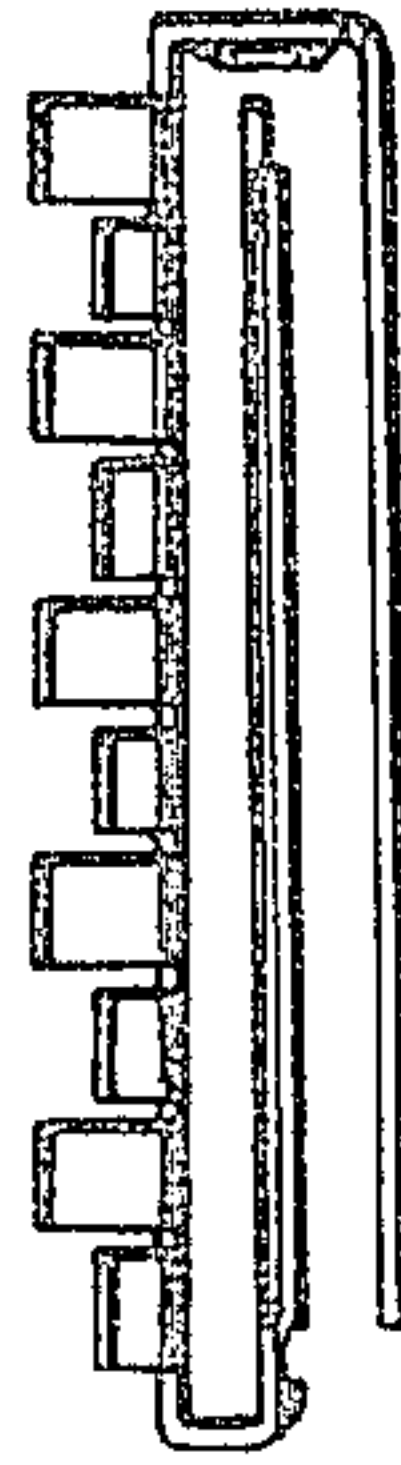


FIG. 2